

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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ZSF200X-A

Category:

Generic Part: Market Group: Description:

ZSF200X SSP

SWITCH FABRIC

Time is money

Parameters

Package	FCBGA 241 (BL1241)
Speed	NA
Temperature	С
Voltage	5.0 V
Status	Active
Sample	Yes
Minimum Order Quantity	1
Factory Order Increment	1

Distributor Inventory

No Pricing information is available from our Distributors at this time.

Documents

No documents available for this part at this time.

Package

Description	FLIP CHIP BGA 40.0 X 40.0 MM X 1.0 MM PI
Class	PLASTIC
Moisture Sensitivity Level (MSL)	4
Category	Standard
Moisture Exposure Floor Life	72 hrs. @ <30°C/60%RH
Peak Reflow Temprature	225°C
Rebake Conditions	48 hrs.@125°C
Length	40.0
Mark	\
Width	40.0
Pitch	1.0
Thickness	2.82
Status	Active